AX-SIP-SFEU, AX-SIP-SFEU-API

Ultra-Low Power, Ultra Compact, AT Command / API Controlled, Sigfox® Verified Transceiver SiP for Up-Link and Down-Link

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OVERVIEW

Circuit Description

AX−SIP−SFEU and AX−SIP−SFEU−API are ultra−low power, ultra compact System−in−Package (SiP) solutions for a node on the Sigfox network with both up− and down−link functionality.

With a footprint of just 7 mm × 9 mm and conformal shielding, the AX−SIP−SFEU SiP, contains all the necessary components and firmware for transmit and receive operation on the European Sigfox network. No additional passive components or reference frequency providing parts are required on the customer's PCB. A single−ended 50 Ω antenna port is provided.

The AX−SIP−SFEU connects to the customer product using a logic level RS232 UART. AT commands are used to send frames and configure radio parameters.

The AX−SIP−SFEU−API variant is intended for customers wishing to write their own application software based on the AX−SIP−SF−LIB−1−GEVK library.

Features

Functionality and Ecosystem

- Single package, zero external components, full Sigfox up−link and down−link functionality controlled by AT commands or API
- The AX−SIP−SFEU and AX−SIP−SFEU−API SiPs are part of a whole development and product ecosystem available from ON Semiconductor for any Sigfox requirement. Other parts of the ecosystem include
  - Ready to go development kit DVK−SIP−SFEU−[API]−1−GEVK including a 2 year Sigfox subscription
- Sigfox® Verified

General Features

- SIP38 9 mm × 7 mm package
- Conformal shielding
- Supply range 2.1 V – 3.6 V
- −30°C to 85°C
- Temperature sensor
- Supply voltage measurements
- 15 GPIO pins
  - 6 GPIO pins with selectable voltage measure functionality, differential (1 V or 10 V range) or single ended (1 V range) with 10 bit resolution
  - 2 GPIO pins with selectable sigma delta DAC output functionality
  - 2 GPIO pins with selectable output clock
  - 3 GPIO pins selectable as SPI master interface
  - Integrated RX/TX switching with single−ended 50 Ω antenna pin

Power Consumption

- Ultra−low Power Consumption:
  - Charge required to send a Sigfox OOB packet at nominal transmitter power (13 dBm typical at nominal temperature): 0.24 C
  - Deep Sleep mode current: 150 nA
  - Sleep mode current: 1.3 μA
  - Standby mode current: 0.55 mA

Features (Continued)

  - Continuous radio RX−mode at 869.525 MHz: 14 mA
  - Continuous radio TX−mode at 868.130 MHz: 45 mA @ nominal transmitter power (13 dBm)

High Performance Narrow−band Sigfox RF Transceiver

- Receiver
  - Carrier frequency 869.525 MHz
  - Data−rate 600 bps FSK
  - Sensitivity −125 dBm @ 600 bps, 869.525 MHz, GFSK
  - 0 dBm maximum input power
- Transmitter
  - Carrier frequency 868.13 MHz
  - Data−rate 100 bps PSK
  - High efficiency, high linearity integrated power amplifier
  - Maximum output power 13 dBm
  - Power level programmable in 1 dBm steps

Applications

- Sigfox networks up−link and down−link

BLOCK DIAGRAM

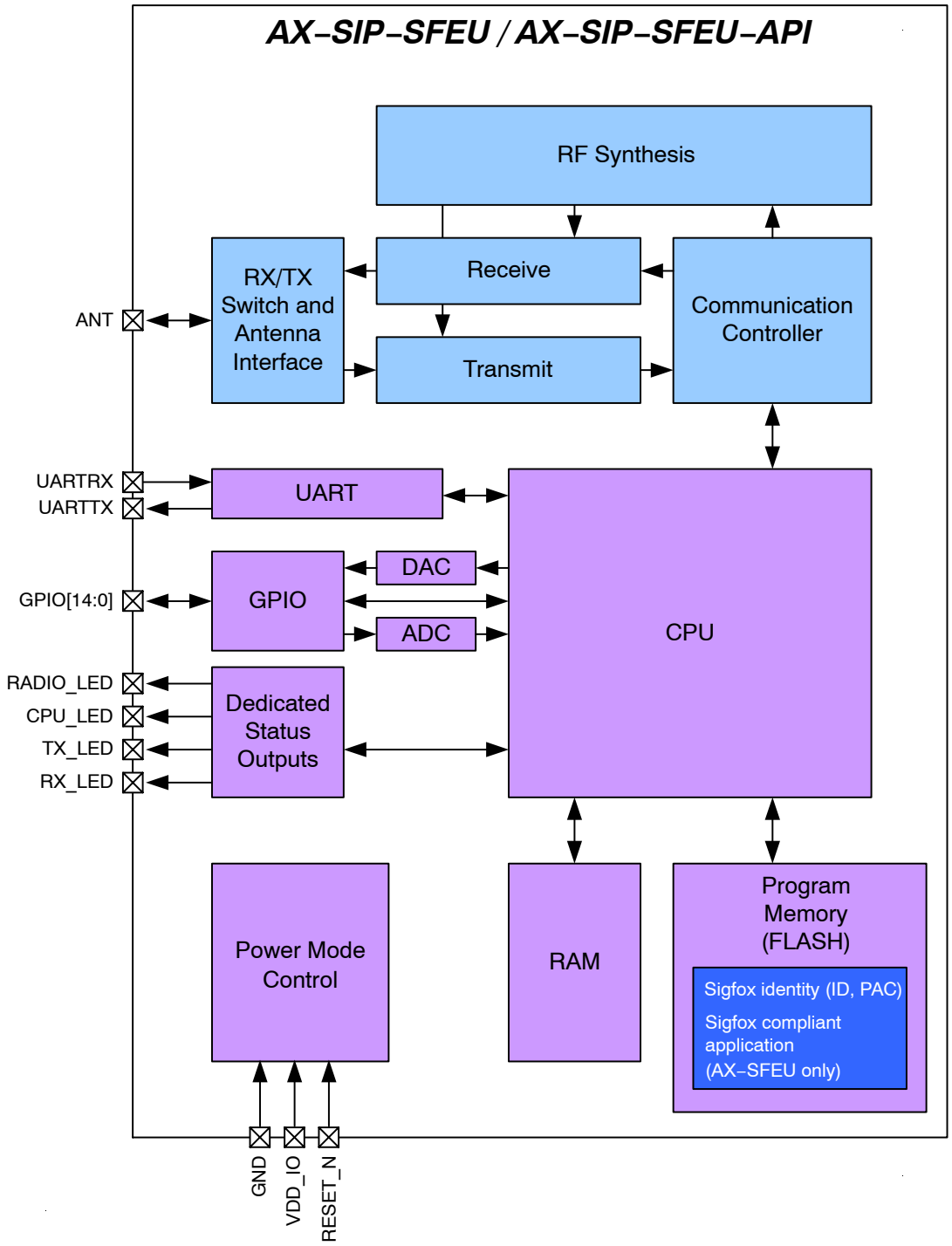


Figure 1. Functional Block Diagram of the AX−SIP−SFEU / AX−SIP−SFEU−API

Table 1. PIN FUNCTION DESCRIPTIONS

Symbol	Pin(s)	Type	Description
GND	1	P	Ground
GND	2	P	Ground
ANT	3	A	Single−ended 50 Ω antenna input/output
GND	4	P	Ground
NC	5	N	Do not connect
GND	6	P	Ground
NC	7	N	Do not connect
NC	8	N	Do not connect
NC	9	N	Do not connect
GPIO11	10	I/O/PU	General purpose IO
GPIO10	11	I/O/PU	General purpose IO
GPIO8	12	I/O/PU	General purpose IO
GPIO7	13	I/O/PU	General purpose IO, selectable SPI functionality (MISO)
GPIO6	14	I/O/PU	General purpose IO, selectable SPI functionality (MOSI)
GPIO5	15	I/O/PU	General purpose IO, selectable SPI functionality (SCK)
GPIO4	16	I/O/PU	General purpose IO, selectable ΣΔ DAC functionality, selectable clock functionality
CPU_LED	17	O	CPU activity indicator
RADIO_LED	18	O	Radio activity indicator
GPIO9	19	I/O/PU	General purpose IO, wakeup from deep sleep
UARTTX	20	O	UART transmit
UARTRX	21	I/PU	UART receive
RX_LED/ DBG_DATA	22	O I/O	Receive activity indicator in AX−SIP−SFEU. Debugger data line in AX−SIP−SFEU−API.
TX_LED/ DBG_CLK	23	O I	Transmit activity indicator in AX−SIP−SFEU. Debugger clock line in AX−SIP−SFEU−API.
NC/DBG_EN	24	PD PD	Do not connect in AX−SIP−SFEU. Debugger enable line in AX−SIP−SFEU−API.
RESET_N	25	I/PU	Optional reset pin. Internal pull−up resistor is permanently enabled, nevertheless it is recommended to connect this pin to VDD_IO if it is not used.
GND	26	P	Ground
VDD_IO	27	P	Unregulated power supply
GPIO0	28	I/O/A/PU	General purpose IO, selectable ADC functionality, selectable ΣΔ DAC functionality, selectable clock functionality
GPIO1	29	I/O/A/PU	General purpose IO, selectable ADC functionality
GPIO2	30	I/O/A/PU	General purpose IO, selectable ADC functionality
NC	31	N	Do not connect
NC	32	N	Do not connect
GPIO3	33	I/O/A/PU	General purpose IO, selectable ADC functionality
GPIO12	34	I/O/A/PU	General purpose IO, selectable ADC functionality
GPIO13	35	I/O/A/PU	General purpose IO, selectable ADC functionality
GPIO14	36	I/O/PU	General purpose IO
NC	37	N	Do not connect
NC	38	N	Do not connect
GND	Center pads	P	Ground on 6 center pads of SIP38, must be connected

A = analog input or input/output
I = digital input signal
O = digital output signal
PU = pull−up
I/O = digital input/output signal
N = not to be connected
P = power or ground
PD = pull−down

All digital inputs are Schmitt trigger inputs, digital input and output levels are LVCMOS/LVTTL compatible. Pins GPIO[3:0] and GPIO[13:12] must not be driven above VDD_IO, all other digital inputs are 5 V tolerant. All GPIO pins and UARTRX start up as input with pull−up. For explanations on how to use the GPIO pins, see chapter “AT Commands”.

0 = pin drives low
1 = pin drives high
Z = pin is high impedance input
U = pin is input with pull−up
A = pin is analog input
T = pin is driven by clock or DAC

Table 2.

Pin	Possible GPIO Modes
GPIO0	0, 1, Z, U, A, T
GPIO1	0, 1, Z, U, A
GPIO2	0, 1, Z, U, A
GPIO3	0, 1, Z, U, A
GPIO4	0, 1, Z, U, T
GPIO5	0, 1, Z, U
GPIO6	0, 1, Z, U
GPIO7	0, 1, Z, U
GPIO8	0, 1, Z, U
GPIO9	0, 1, Z, U
GPIO10	0, 1, Z, U
GPIO11	0, 1, Z, U
GPIO12	0, 1, Z, U, A
GPIO13	0, 1, Z, U, A
GPIO14	0, 1, Z, U

Pinout Drawing

Pins 22−24 have different functionalities in AT command and API versions, so for these pins AX−SIP−SFEU/AX−SIP−SFEU−API explanations are shown respectively.

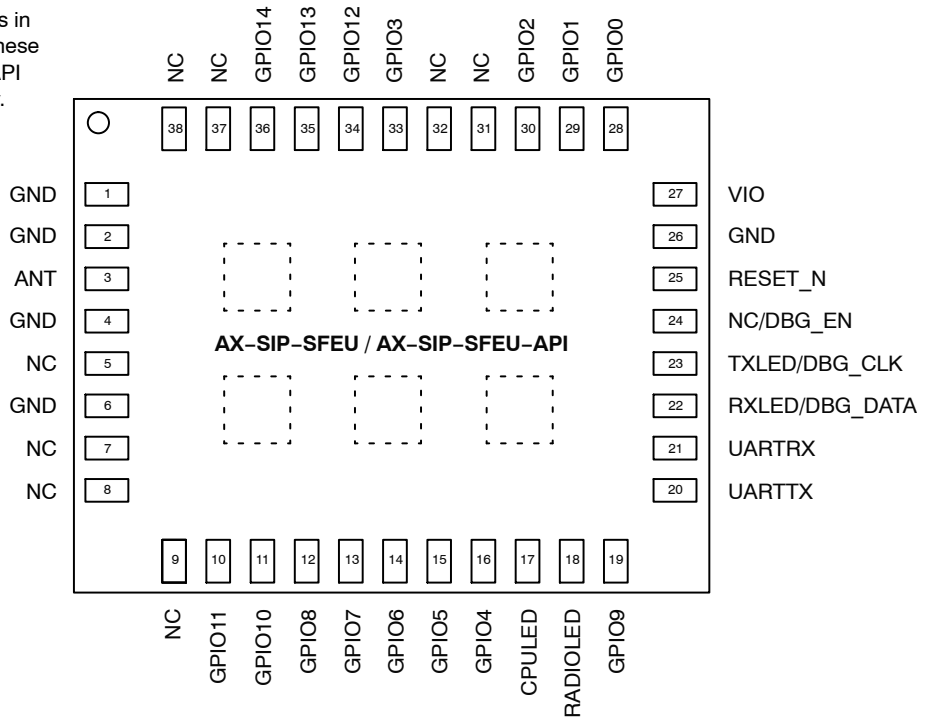


Figure 2. Pinout Drawing (Top View)

SPECIFICATIONS

Table 3. ABSOLUTE MAXIMUM RATINGS

Symbol	Description	Condition	Min	Max	Units
VDD_IO	Supply voltage		−0.5	3.8	V
IDD	Supply current			200	mA
P_{tot}	Total power consumption			800	mW
P_i	Absolute maximum input power at receiver input	ANT pin in RX mode		10	dBm
I_{I1}	DC current into any pin except ANT		−10	10	mA
I_{I2}	DC current into pin ANT		−100	100	mA
I_O	Output Current			40	mA
V_{ia}	Input voltage ANT pin		−0.5	3.8	V
	Input voltage digital pins		−0.5	5.5	V
V_{es}	Electrostatic handling	HBM	−2000	2000	V
T_{amb}	Operating temperature		−30	85	°C
T_{stg}	Storage temperature		−30	85	°C
T_j	Junction Temperature			150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC Characteristics

Table 4. SUPPLIES

(Conditions for all current and charge values unless otherwise specified are for the DVK−SIP−SFEU−1−GEVK hardware configuration.)

Symbol	Description	Condition	Min	Typ	Max	Units
T_{AMB}	Operational ambient temperature		−30	27	85	°C
VDD_{IO}	I/O and voltage regulator supply voltage		2.1	3.0	3.6	V
$VDD_{IO\ R1}$	I/O voltage ramp for reset activation (Note 2)	Ramp starts at VDD IO ≤ 0.1 V	0.1			V/ms
$VDD_{IO\ R2}$	I/O voltage ramp for reset activation (Note 2)	Ramp starts at 0.1 V < VDD IO < 0.7 V	3.3			V/ms
I_{DS}	Deep sleep mode current	AT$P = 2		150		nA
I_{SLP}	Sleep mode current	AT$P = 1		1.3		μA
I_{STDBY}	Standby mode current (Note 3)			0.55		mA
I_{RX_CONT}	Current consumption continuous RX	AT$SE		14		Ma
$Q_{SFX\_OOB\_14}$	Charge to send a Sigfox out of band message, nominal transmitter power (Note 4)	AT$SO		0.24		C
$Q_{SFX\_BIT\_14}$	Charge to send a bit, nominal transmitter power (Note 4)	AT$SB = 0		0.16		C
$Q_{SFX\_BITDL\_14}$	Charge to send a bit with downlink receive, nominal transmitter power (Note 4)	AT$SB = 0,1		0.44		C
$Q_{SFX\_LFR\_14}$	Charge to send the longest possible Sigfox frame (12 byte), nominal transmitter power (Note 4)	AT$SF = 00112233445566778899aabb		0.29		C
$Q_{SFX\_LFRDL\_14}$	Charge to send the longest possible Sigfox frame (12 byte) with downlink receive, nominal transmitter power (Note 4)	AT$SF = 00112233445566778899aabb,1		0.57		C
$I_{TXMOD14AVG}$	Modulated Transmitter Current (Note 5)	P_{out} = 13 dBm; average		45		mA

2. If VDD_IO ramps cannot be guaranteed, an external reset circuit is recommended, see the AX8052 Application Note: Power On Reset.
3. 20 MHz Fast RC oscillator, voltage conditioning and supervisory circuit running.
4. Power setting 14, which gives 13 dBm typical power at nominal temperature.
5. Current consumption value is given for a matching network that is optimized for maximum power (setting 14, also nominal setting).

Typical Current Waveform

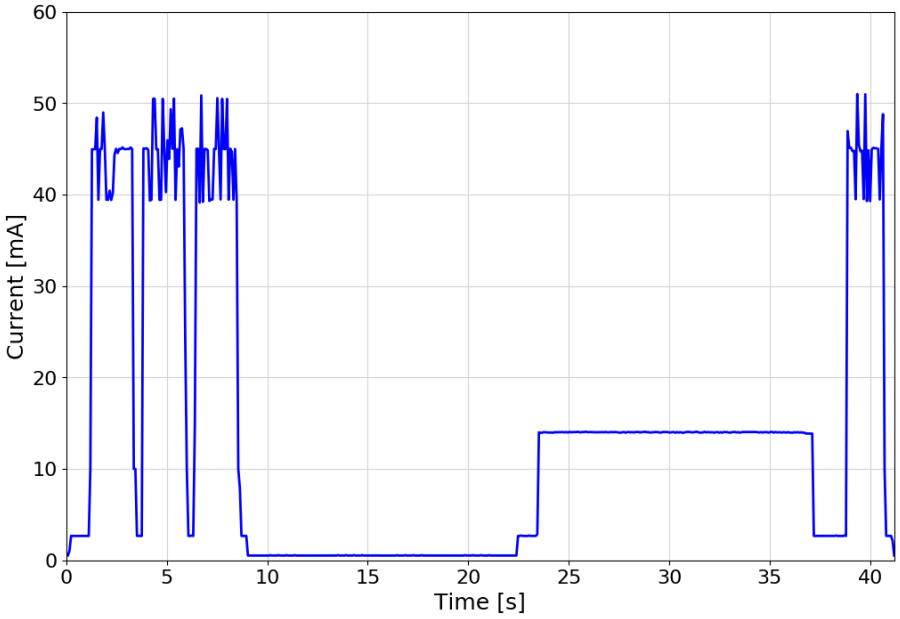


Figure 3. Typical Current Waveform for a Maximum Length Frame with Downlink Receive at Nominal Transmitter Power

Battery Life Example

- 2 AAA Alkaline batteries in series
- One OOB frame transmitter per day at nominal transmitter power (P_{out} = 13 dBm typical)
- Four maximum length frames with downlink receive per day at nominal transmitter power (P_{out} = 13 dBm typical)
- Device in Sleep
- Neglecting battery self−discharge

2 AAA alkaline capacity	1500 mAh × 3600 s/h	5400 C
Sleep charge per day	1.3 μA × 86400 s	0.11 C/day
OOB frame transmission		0.24 C/day
Frame transmission with downlink	4 × 0.57 C/day	2.28 C/day
Total Charge consumption		2.63 C/day
Battery life		5.5 Years

Table 5. LOGIC

Symbol	Description	Condition	Min	Typ	Max	Units
DIGITAL INPUTS						
V_{T+}	Schmitt trigger low to high threshold point	VDD_IO = 3.3 V		1.55		V
V_{T-}	Schmitt trigger high to low threshold point			1.25		V
V_{IL}	Input voltage, low				0.8	V
V_{IH}	Input voltage, high		2.0			V
V_{IPA}	Input voltage range, GPIO[3:0] and GPIO[13:12]		−0.5		VDD_IO	V
V_{IPBC}	Input voltage range, GPIO[9:4], UARTRX		−0.5		5.5	V
I_L	Input leakage current		−10		10	μA
R_{PU}	Programmable Pull−Up Resistance			65		kΩ
DIGITAL OUTPUTS						
I_{OH}	Output Current, high GPIO[14:0], UARTTX, TXLED, RXLED, TXLED, CPULED	V_{OH} = 2.4 V	8			mA
I_{OL}	Output Current, low GPIO[14:0], UARTTX, TXLED, RXLED, TXLED, CPULED	V_{OL} = 0.4 V	8			mA
I_{OZ}	Tri−state output leakage current		−10		10	μA

AC Characteristics

Table 6. TRANSMITTER

(Conditions for transmitter specifications unless otherwise specified are for DVK−SIP−SFEU−1−GVK hardware configuration and at 868.130 MHz frequency.)

Symbol	Description	Condition	Min	Typ	Max	Units
SBR	Signal bit rate			100		bps
PTX_{min}	Lowest Transmitter output power (Note 6)	AT$CW=868130000,1,0		−1		dBm
PTX_{max}	Highest Transmitter output power (Note 6)	AT$CW=868130000,1,14		13		dBm
PTX_{step}	Programming step size output power			1		dB
dTX_{temp}	Transmitter power variation vs. temperature	−30°C to +85°C		±0.8		dB
dTX_{Vdd}	Transmitter power variation vs. VDD_IO	2.1 to 3.6 V		±0.03		dB
PTX_{harm2}	Emission @ 2nd harmonic			−58		dBc
PTX_{harm3}	Emission @ 3rd harmonic			−80		
PTX_{harm4}	Emission @ 4th harmonic			−86		

6. The output power of the AX−SIP−SFEU / AX−SIP−SFEU−API can be programmed in 1 dB steps, by changing transmitter power setting from 0 − 14. The lowest power setting is 0, which gives −1 dBm typical power at nominal temperature. The highest power setting is 14, which gives 13 dBm typical power at nominal temperature and close to 14 dBm typical power at minimum temperature.

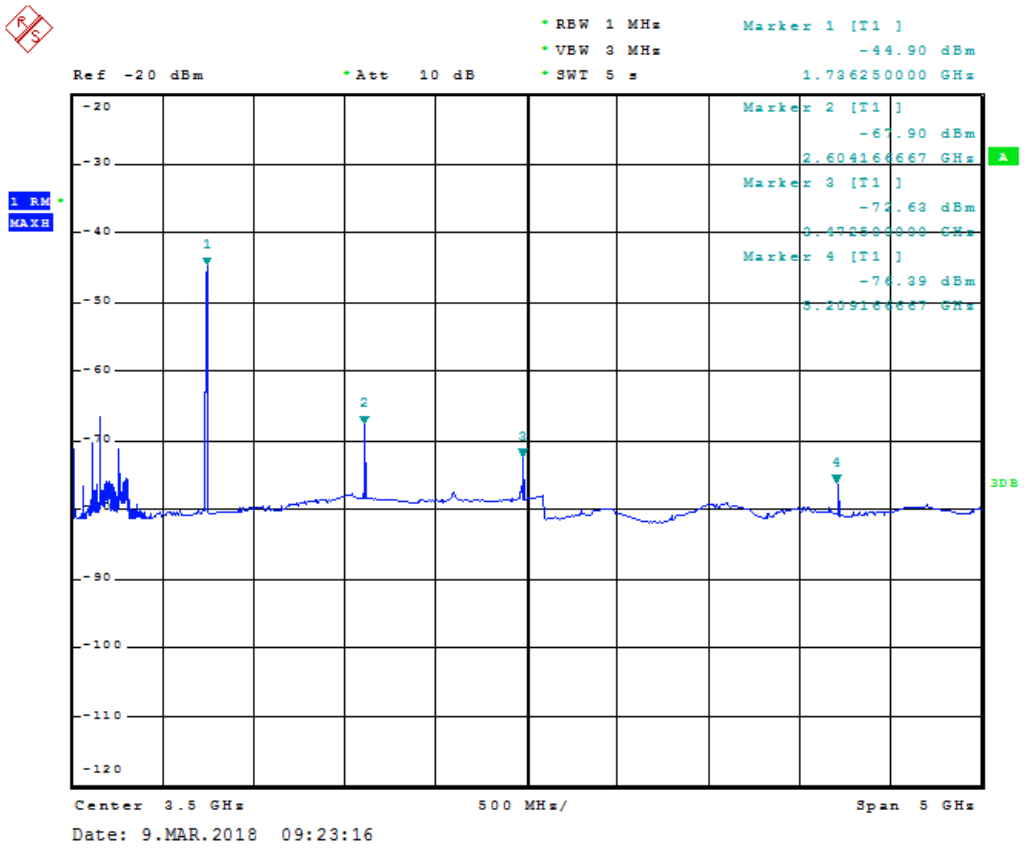


Figure 4. Typical Spectrum with Harmonics at Nominal Output Power

Table 7. RECEIVER

(Conditions for receiver specifications unless otherwise specified are for DVK−SIP−SFEU−1−GEVK hardware configuration and at 869.525 MHz frequency.)

Symbol	Description	Condition	Min	Typ	Max	Units
SBR	Signal bit rate			600		bps
IS_{BER868}	Sensitivity	Evaluated at BER > 10^{-3}. AT command used: AT$PN=4,5		−125		dBm
BLK_{2M-868}	Blocking level at ±2 MHz offset	Evaluated at BER > 10^{-3}. Wanted signal is +3 dB above the typical sensitivity, the blocker signal is CW. AT command used: AT$PN=4,5.		−53		dBm
$BLK_{10M-868}$	Blocking level at ±10 MHz offset	Evaluated at BER > 10^{-3}. Wanted signal is +3 dB above the typical sensitivity, the blocker signal is CW. AT command used: AT$PN=4,5.		−32		dBm

Table 8. ADC/TEMPERATURE SENSOR

Symbol	Description	Condition	Min	Typ	Max	Units
ADCRES	ADC resolution			10		Bits
V_{ADCREF}	ADC reference voltage		0.95	1	1.05	V
Z_{ADC00}	Input capacitance				2.5	pF
DNL	Differential nonlinearity			±1		LSB
INL	Integral nonlinearity			±1		LSB
OFF	Offset			3		LSB
GAIN_ERR	Gain error			0.8		%
ADC IN DIFFERENTIAL MODE						
V_{ABS_DIFF}	Absolute voltages & common mode voltage in differential mode at each input		0		VDD_IO	V
V_{FS_DIFF01}	Full swing input for differential signals	Gain ×1	−500		500	mV
V_{FS_DIFF10}		Gain ×10	−50		50	mV
ADC IN SINGLE ENDED MODE						
V_{MID_SE}	Mid code input voltage in single ended mode			0.5		V
V_{IN_SE00}	Input voltage in single ended mode		0		VDD_IO	V
V_{FS_SE01}	Full swing input for single ended signals	Gain ×1	0		1	V
TEMPERATURE SENSOR						
T_{RNG}	Temperature range	AT$T?	−30		85	°C

COMMAND INTERFACE

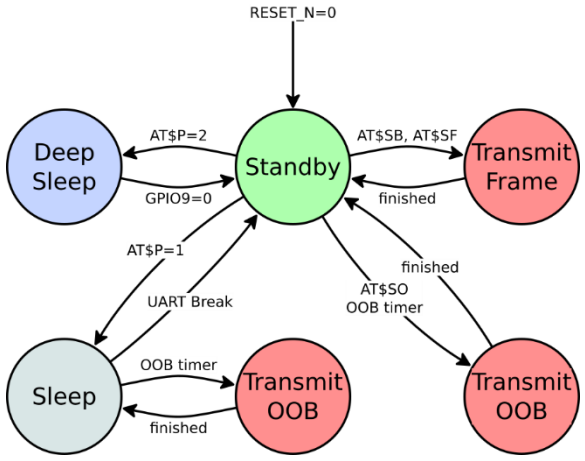
General Information

The chapter “Command Interface” is a documentation of the AT−Command set for devices which do not have an API−interface. To see whether the device is capable of receiving AT−Commands, please refer to the table “Device Versions”. If the device has been shipped with the API−Interface, please refer to the SW manual and “apiexample” code delivered with AX−SIP−SF−LIB−1−GEVK for an introduction on how to setup a project and how to use the API−Interface.

Serial Parameters: 9600, 8, N, 1

The AX−SIP−SFEU uses the UART (pins UARTTX, UARTRX) to communicate with a host and uses a bitrate of **9600 baud**, no parity, 8 data bits and one stop bit.

Power Modes



Standby

After Power−Up and after finishing a Sigfox transmission, AX−SIP−SFEU enters Standby mode. In Standby mode, AX−SIP−SFEU listens on the UART for commands from the host. Also, OOB frames are transmitted whenever the OOB timer fires. To conserve power, the AX−SIP−SFEU can be put into Sleep or turned off (Deep Sleep) completely.

Sleep

The command **AT$P=1** is used to put the AX−SIP−SFEU into Sleep mode. In this mode, only the wakeup timer for out−of−band messages is still running. To wake the AX−SIP−SFEU up from Sleep mode toggle the serial UARTRX pin, e.g. by sending a break (break is an RS232 framing violation, i.e. at least 10 bit durations low). When an Out of Band (OOB) message is due, AX−SIP−SFEU automatically wakes up to transmit the message, and then returns to Sleep mode.

Deep Sleep

In Deep Sleep mode, the AX−SIP−SFEU is completely turned off and only draws negligible leakage current.

Deep Sleep mode can be activated with **AT$P=2**. To wake−up from Deep Sleep mode, GPIO9 is pulled to GND.

When using Deep Sleep mode, keep two things in mind: Everything is turned off, timers are not running at all and all settings will be lost (use **AT$WR** to save settings to flash before entering Deep Sleep mode). Out−of−band messages will therefore not be sent. The pins states are frozen in Deep Sleep mode. The user must ensure that this will not result in condition which would draw a lot of current.

AT Commands

Numerical Syntax

```
hexdigit ::= [0-9A-Fa-f]
Hexnum ::= "0x" hexdigit+
decnum ::= "0" | [1-9] [0-9]*
octnum ::= "0" [0-7]+
binnum ::= "0b" [01]+
bit ::= [01]
optnum ::= "-1"
Frame ::= (hexdigit hexdigit)+
uint ::= hexnum | decnum | octnum | binnum
uint_opt  ::= uint | optnum
```

Command Syntax

A command starts with ‘AT’ (everything is case sensitive!), continues with the actual command followed by parameters (if any) and ends with any kind of whitespace (space, tab, newline etc.)

If incorrect syntax is detected (“parsing error”) all input is ignored up until the next whitespace character.

Also note that any number can be entered in any format (Hexadecimal, Decimal, Octal and binary) by adding the corresponding prefix (‘0x’, ‘0’, ‘0b’). The only exception is the ‘Send Frame’ command (`AT$SF`) which expects a list of hexadecimal digits without any prefix.

Return Codes

A successful command execution is indicated by sending ‘OK’. If a command returns a value (e.g. by querying a register) only the value is returned.

Examples

Bold text is sent to AX−SIP−SFEU.

AT$I=0
AX−SF 1.1−RC1

Here, we execute command ‘I’ to query some general information.

AT$SF=aabb1234
OK

This sends a Sigfox frame containing {0xAA : 0xBB : 0x12 : 0x34} without waiting for a response telegram.

AT$SF=0011223344,1
OK
RX=AA BB CC DD

This sends a Sigfox frame containing {0x00 : 0x11 : 0x22 : 0x33 : 0x44}, then waits for a downlink response telegram, which in this example contains {0xAA : 0xBB : 0xCC : 0xDD}.

AT$CB=0xAA,1
OK

The ‘CB’ command sends out a continuous pattern of bits, in this case 0xAA = 0b10101010.

AT$P=1
OK

This transitions the device into sleep mode. Out−of−band transmissions will still be triggered. The UART is powered down. The device can be woken up by a low level on the UART signal, i.e. by sending break.

Table 9. COMMANDS

Command	Name	Description
AT	Dummy Command	Just returns 'OK' and does nothing else. Can be used to check communication.
AT$SB=bit[,bit]	Send Bit	Send a bit status (0 or 1). Optional bit flag indicates if AX−SIP−SFEU should receive a downlink frame.
AT$SF=frame[,bit]	Send Frame	Send payload data, 1 to 12 bytes. Optional bit flag indicates if AX−SIP−SFEU should receive a downlink frame.
AT$SO	Manually send out of band message	Send the out−of−band message.
AT$TR?	Get the transmit repeat	Returns the number of transmit repeats. Default: 2
AT$TR=?	Get transmit repeat range	Returns the allowed range of transmit repeats.
AT$TR=uint	Set transmit repeat	Sets the transmit repeat, sets only for transmit with downlink frame.
ATSuint?	Get Register	Query a specific configuration register's value. See Table 10 "Registers" for a list of registers.
ATSuint=int	Set Register	Change a configuration register.
ATSuint=?	Get Register Range	Returns the allowed range of the register values.
AT$IF=uint	Set TX Frequency	Set the output carrier macro channel for Sigfox frames.
AT$IF?	Get TX Frequency	Get the currently chosen TX frequency.
AT$DR=uint	Set RX Frequency	Set the reception carrier macro channel for Sigfox frames.
AT$DR?	Get RX Frequency	Get the currently chosen RX frequency.
AT$CW=uint,bit[,uint_opt]	Continuous Wave	To run emission tests for Sigfox certification it is necessary to send a continuous wave, i.e. just the base frequency without any modulation. Parameters: **Name** / **Range** / **Description** Frequency / 800000000−999999999, 0 / Continuous wave frequency in Hz. Use 868130000 for Sigfox or 0 to keep previous frequency. Mode / 0, 1 / Enable or disable carrier wave. Power / 0−14 / Signal power setting | Default: 14
AT$CB=uint_opt,bit	Test Mode: TX constant byte	For emission testing it is useful to send a specific bit pattern. The first parameter specifies the byte to send. Use '−1' for a (pseudo−)random pattern. Parameters: **Name** / **Range** / **Description** Pattern / 0−255, −1 / Byte to send. Use '−1' for a (pseudo−)random pattern. Mode / 0, 1 / Enable or disable pattern test mode.
AT$T?	Get Temperature	Measure internal temperature and return it in 1/10th of a degree Celsius.
AT$V?	Get Voltages	Return current voltage and voltage measured during the last transmission in mV.

Table 9. COMMANDS (continued)

Command	Name	Description
AT$I=uint	Information	Display various product information: 0: Software Name & Version Example Response: AX−SF 1.1−RC1 1: Contact Details Example Response: onhelp@onsemi.com 2: Silicon revision lower byte Example Response: 90 3: Silicon revision upper byte Example Response: 51 4: Major Firmware Version Example Response: 1 5: Minor Firmware Version Example Response: 1 7: Firmware Variant (Frequency Band etc. (EU/US)) Example Response: RC1 8: Firmware VCS Version Example Response: 0 9: Sigfox Library Version Example Response: UDL1−1.8.9 10: Device ID Example Response: 00012345 11: PAC Example Response: 0123456789ABCDEF
AT$P=uint	Set Power Mode	To conserve power, the AX−SIP−SFEU can be put to sleep manually. Depending on power mode, you will be responsible for waking up the AX−SIP−SFEU again! 0: software reset (settings will be reset to values in flash) 1: sleep (send a break to wake up) 2: deep sleep (toggle GPIO9 or RESET_N pin to wake up; the AX−SIP−SFEU is not running and all settings will be reset!)
AT$WR	Save Config	Write all settings to flash (RX/TX frequencies, registers) so they survive reset/deep sleep or loss of power. Use AT$P=0 to reset the AX−SIP−SFEU and load settings from flash.
AT:Pn?	Get GPIO Pin	Return the setting of the GPIO Pin *n*; *n* can range from 0 to 14. A character string is returned describing the mode of the pin, followed by the actual value. If the pin is configured as analog pin, then the voltage (range 0…1 V) is returned. The mode characters have the following meaning: **Mode** **Description** 0 Pin drives low 1 Pin drives high Z Pin is high impedance input U Pin is input with pull−up A Pin is analog input (GPIO pin 0…3 and 12…13 only) T Pin is driven by clock or DAC (GPIO pin 0 and 4 only) The default mode after exiting reset is U on all GPIO pins.

Table 9. COMMANDS (continued)

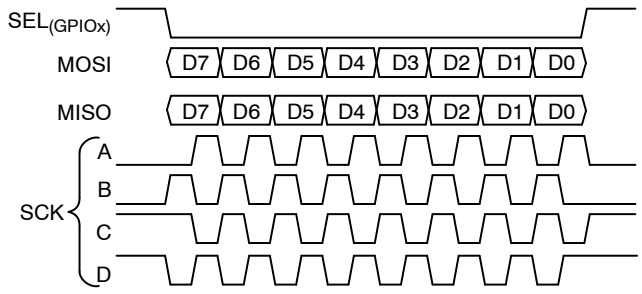
Command	Name	Description
AT:Pn=?	Get GPIO Pin Range	Print a list of possible modes for a pin. The table below lists the response. **Pin** **Modes** P0 0, 1, Z, U, A, T P1 0, 1, Z, U, A P2 0, 1, Z, U, A P3 0, 1, Z, U, A P4 0, 1, Z, U, T P5 0, 1, Z, U P6 0, 1, Z, U P7 0, 1, Z, U P8 0, 1, Z, U P9 0, 1, Z, U P10 0, 1, Z, U P11 0, 1, Z, U P12 0, 1, Z, U, A P13 0, 1, Z, U, A P14 0, 1, Z, U
AT:Pn=mode	Set GPIO Pin	Set the GPIO pin mode. For a list of the modes see the command AT:Pn?
AT:ADC Pn[−Pn[(1V|10V)]]?	Get GPIO Pin Analog Voltage	Measure the voltage applied to a GPIO pin. The command also allows measurement of the voltage difference across two GPIO pins. In differential mode, the full scale range may also be specified as 1 V or 10 V. Note however that the pin input voltages must not exceed the range 0…VDD_IO. The command returns the result as fraction of the full scale range (1 V if none is specified). The GPIO pins referenced should be initialized to analog mode before issuing this command.
AT:SPI[(A|B|C|D)]=bytes	SPI Transaction	This command clocks out *bytes* on the SPI port. The clock frequency is 312.5 kHz. The command returns the bytes read on MISO during output. Optionally the clocking mode may be specified (default is A): **Mode** **Clock Inversion** **Clock Phase** A normal normal B normal alternate C inverted normal D inverted alternate  Note that SEL, if needed, is not generated by this command, and must instead be driven using standard GPIO commands (AT:Pn=0|1).
AT:CLK=freq,reffreq	Set Clock Generator	Output a square wave on the pin(s) set to T mode. The frequency of the square wave is (freq / 2^{16}) × reffreq. Possible values for reffreq are 20000000, 10000000, 5000000, 2500000, 1250000, 625000, 312500, 156250. Possible values for freq are 0…65535.
AT:CLK=OFF	Turn off Clock Generator	Switch off the clock generator
AT:CLK?	Get Clock Generator	Return the settings of the clock generator. Two numbers are returned, freq and reffreq.
AT:DAC=value	Set ΣΔ DAC	Output a ΣΔ DAC value on the pin(s) set to T mode. Parameter value may be in the range −32768…32767. The average output voltage is (1/2 + value / 2^{17}) × VDD. An external low pass filter is needed to get smooth output voltages. The modulation frequency is 20 MHz. A possible low pass filter choice is a simple RC low pass filter with R = 10 kΩ and C = 1 μF.

Table 9. COMMANDS (continued)

Command	Name	Description
AT:DAC=OFF	Turn off ΣΔ DAC	Switch off the DAC
AT:DAC?	Get ΣΔ DAC	Return the DAC value
AT$TM=mode,config	Activates the Sigfox Testmode	Available test modes: 0. TX BPSK Send only BPSK with Synchro Bit + Synchro frame + PN sequence: No hopping centered on the TX_frequency. Config bits 0 to 6 define the number of repetitions. Bit 7 of config defines if a delay is applied or not between the frames in the loop (1 means no delay). 1. TX Protocol: Tx mode with full protocol with Sigfox key: Send Sigfox protocol frames with initiate downlink flag = True. Config defines the number of repetitions. 2. RX Protocol: This mode tests the complete downlink protocol in Downlink only. Config defines the number of repetitions. 3. RX GFSK: RX mode with known pattern with SB + SF + Pattern on RX_frequency (internal comparison with received frame ⇔ known pattern = AA AA B2 27 1F 20 41 84 32 68 C5 BA AE 79 E7 F6 DD 9B. Config defines the number of repetitions. 4. RX Sensitivity: Does uplink + downlink frame with Sigfox key and specific timings. This test is specific to Sigfox's test equipment & software. 5. TX Synthesis: Does one uplink frame on each Sigfox channel to measure frequency synthesis step.
AT$SE	Starts AT$TM=3,255 indefinitely	Convenience command for sensitivity tests
AT$SL[=frame]	Send local loop	Sends a local loop frame with optional payload of 1 to 12 bytes. Default payload: 0x84, 0x32, 0x68, 0xC5, 0xBA, 0x53, 0xAE, 0x79, 0xE7, 0xF6, 0xDD, 0x9B.
AT$RL	Receive local loop	Starts listening for a local loop.
AT$TP=repetitions	Transient power measurements mode	Used for transmitter transient power measurements. The command switches the transmitter ON and OFF. During ON state (pseudo) random bit pattern is send. Repetitions is the number of performed measurements, acceptable range is 1−255.
AT$PN=mode,repetitions	Send & Receive PN9 bitstream for BER measurements	Available modes: 0: send PN9 bit stream. Repetitions = 1 is required to start sending. Repetitions = 0 stops sending 3: receive PN9 bit stream, calculate BER with 3 digits precision 4: receive PN9 bit stream, calculate BER with 4 digits precision 5: receive PN9 bit stream, calculate BER with 5 digits precision Mode = 3−5 receives the PN9 bitstream and decodes it into an actual BER measurement. Reports the BER for each repetition. Repetitions is the number of performed measurements, acceptable range is 1−255. Higher precision result takes longer time to compute. PN9 is 9−bit pseudo random binary sequence.

Table 10. REGISTERS

Number	Name	Description	Default	Range	Units
300	Out Of Band Period	AX−SIP−SFEU sends periodic static messages to indicate that it is alive. Set to 0 to disable.	24	0−24	hours
302	Power Level	The output power of the radio.	14	0−14	0: −1dBm 14: 13 dBm
410	Encryption Key Configuration	Set to zero for normal operation. Set to one for use with the Sigfox Network Emulator (SNEK).	0	0−1	0: private key 1: public key
411	Specific ID and Key for certification	Set to zero for use of regular device ID and key. Set to one to use specific ID and key for test sample devices for Sigfox certification.	0	0−1	0: regular sample 1: test sample
500	RSSI Offset	RSSI offset value can be applied to fine tune the RSSI level that the device reports.	0	−128…127	dB

APPLICATION INFORMATION

Typical Application Diagrams

Typical AX−SIP−SFEU / AX−SIP−SFEU−API Application Diagram

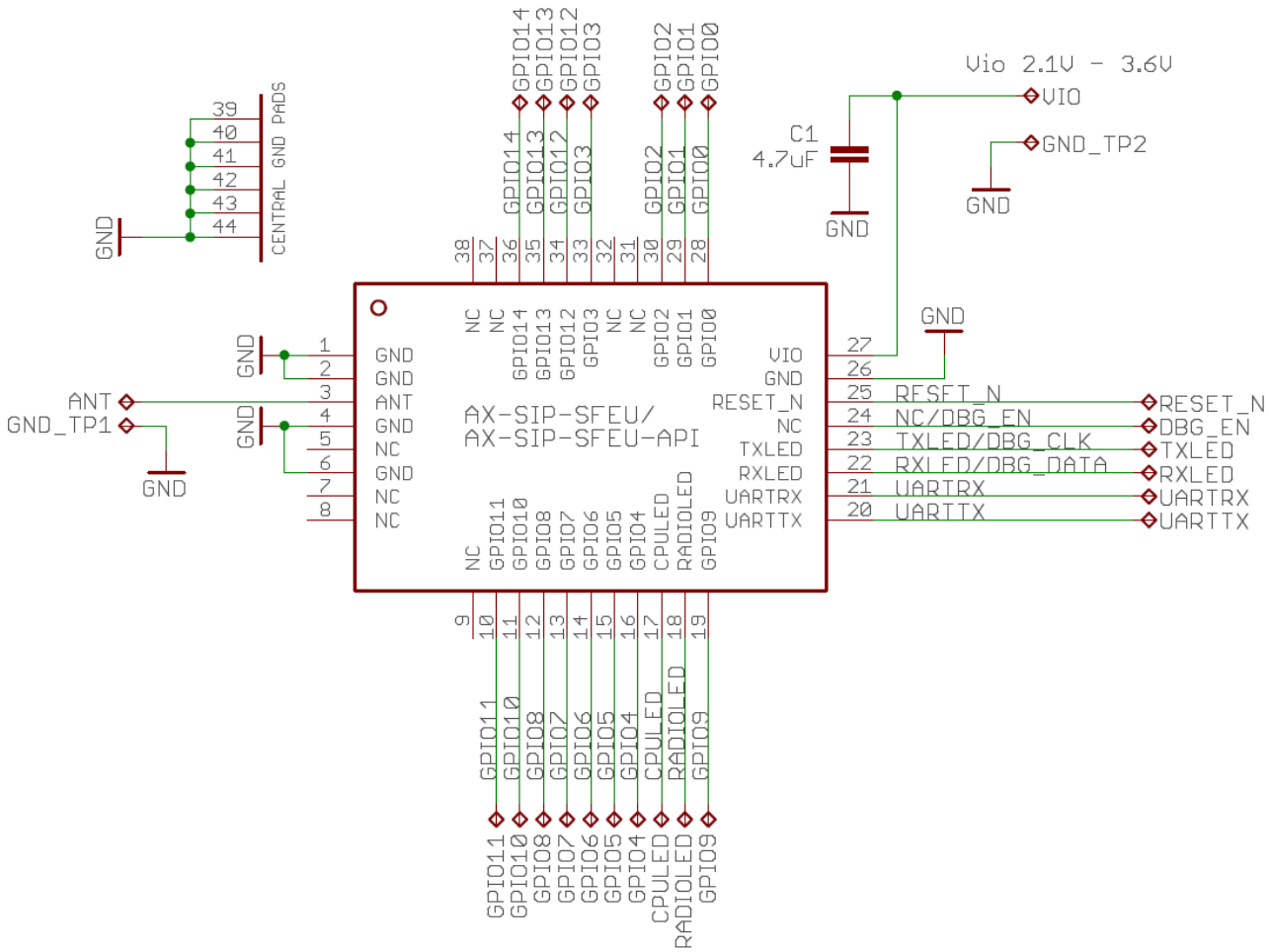


Figure 5. Typical Application Diagram

SIP38 RECOMMENDED PAD LAYOUT

1. PCB land and solder masking recommendations are shown in Figure 6.

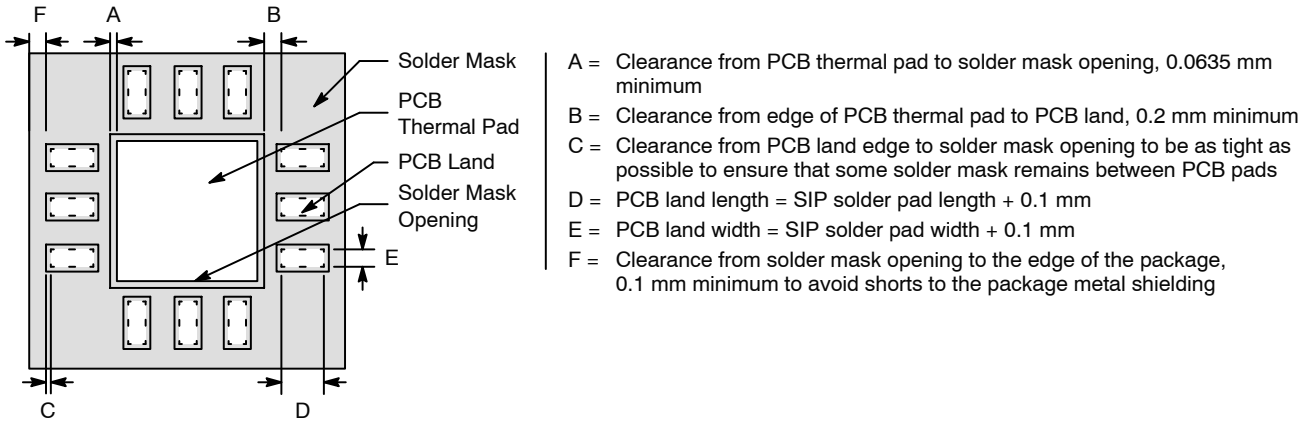


Figure 6. PCB Land and Solder Mask Recommendations

2. Thermal vias should be used around the PCB thermal pads (middle ground pads) to improve thermal conductivity from the device to a copper ground plane area on the reverse side of the printed circuit board. The number of vias depends on the package thermal requirements, as determined by thermal simulation or actual testing.
3. Increasing the number of vias through the printed circuit board will improve the thermal conductivity to the reverse side ground plane and external heat sink. In general, adding more metal through the PC board under the SiP will improve operational heat transfer, but will require careful attention to uniform heating of the board during assembly.

Assembly Process

Stencil Design & Solder Paste Application

1. Stainless steel stencils are recommended for solder paste application.
2. A stencil thickness of 0.125–0.150 mm (5–6 mils) is recommended for screening.
3. For the PCB thermal pads, solder paste should be printed on the PCB by designing a stencil with an array of 6 openings for each of the 6 thermal/GND pads.
4. The aperture opening for the signal pads should be between 50−80% of the SIP pad area as shown in Figure 7.
5. Optionally, for better solder paste release, the aperture walls should be trapezoidal and the corners rounded.
6. The fine pitch of the SiP leads requires accurate alignment of the stencil and the printed circuit board. The stencil and printed circuit assembly should be aligned to within + 1 mil prior to application of the solder paste.
7. No−clean flux is recommended since flux from underneath the thermal pad will be difficult to clean if water−soluble flux is used.

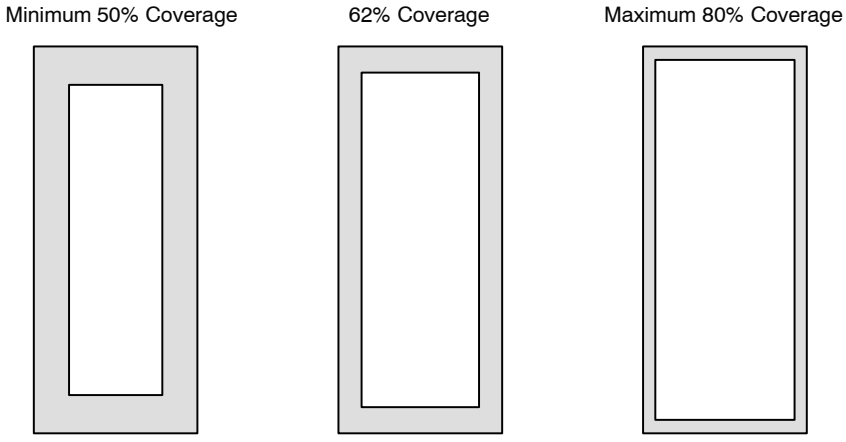


Figure 7. Solder Paste Application on Pins

Life Support Applications

This product is not designed for use in life support appliances, devices or in systems where malfunction of this product can reasonably be expected to result in personal injury. ON Semiconductor customers using or selling this product for use in such applications do so at their own risk and agree to fully indemnify ON Semiconductor for any damages resulting from such improper use or sale.

Device Information

The following device information can be queried using the AT−Commands AT$I=4, AT$I=5 for the APP version and AT$I=2, AT$I=3 for the chip version.

Table 11. DEVICE VERSIONS

Product Sigfox and is a registered trademark of Sigfox SARL.	Part Number	APP Version		SiP Version	
		[0]	[1]	[0]	[1]
AX−SIP−SFEU	AX−SIP−SFEU−1−01−TX30	0x01	0x01	0x90	0x51
AX−SIP−SFEU−API	AX−SIP−SFEU−API−1−01−TX30	0x01	0x01	0x90	0x51

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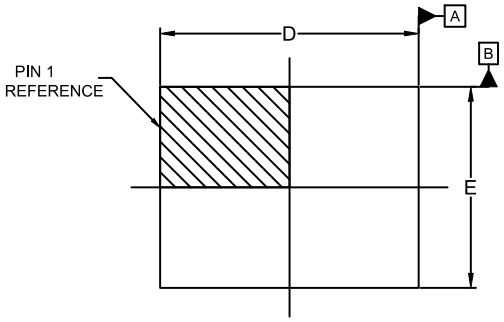
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

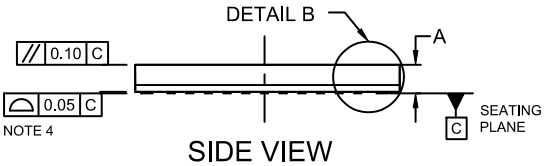
ON Semiconductor®

SIP38 9x7
CASE 127EU
ISSUE A

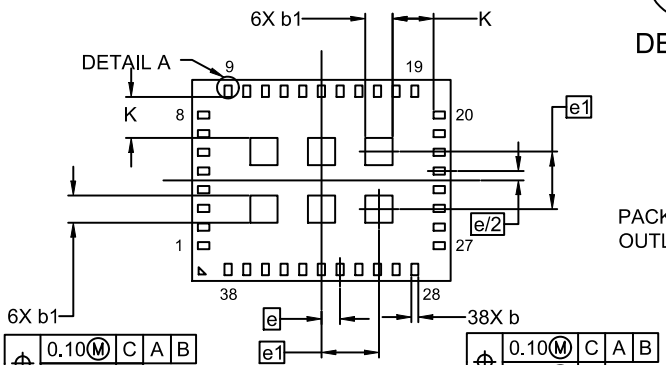
DATE 14 MAR 2018



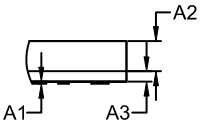
TOP VIEW



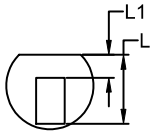
SIDE VIEW



NOTE 3 BOTTOM VIEW NOTE 3



DETAIL B

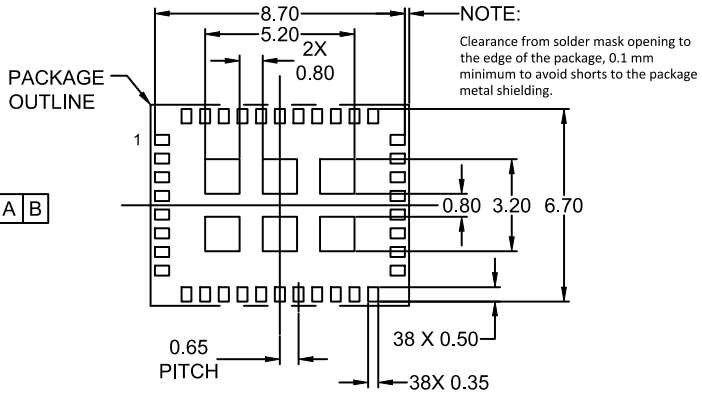


DETAIL A

NOTES:

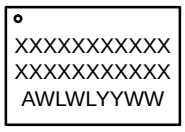
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b and b1 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
A	---	---	0.996
A1	---	---	0.05
A2	---	0.70	0.73
A3	---	0.24	0.28
b	0.20	0.25	0.30
b1	0.90	0.95	1.00
D	8.90	9.00	9.10
E	6.90	7.00	7.10
e	0.65 BSC		
e1	2.00 BSC		
K	1.42 REF		
L	0.55	0.60	0.65
L1	0.20 REF		



RECOMMENDED
MOUNTING FOOTPRINT

GENERIC
MARKING DIAGRAM*



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present. Some products may not follow the Generic Marking.

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